



THC63LVD1027

Dual Link LVDS Repeater

General Description

The THC63LVD1027 LVDS(Low Voltage Differential Signaling) repeater is designed to support pixel data transmission between Host and Flat Panel Display up to WUXGA resolution.

THC63LVD1027 receives the dual link LVDS data streams and transmits the LVDS data through various line rate conversion modes, Dual Link Input / Dual Link Output, Single Link Input / Dual Link Output, and Dual Link Input / Single Link Output.

Features

- 30bits/pixel dual link LVDS Receiver
- 30bits/pixel dual Link LVDS Transmitter
- Operating Temperature Range : -40°C~85°C
- Wide LVDS input skew margin: ± 480ps at 75MHz
- Accurate LVDS output timing: ± 250ps at 75MHz
- Reduced swing LVDS output mode supported to suppress the system EMI
- Various line rate conversion modes supported Dual link input / Dual link output [clkout=1x clkin] Single link input / Dual link output [clkout=1/2x clkin] Dual link input / Single link output [clkout=2x clkin]
- Distribution (signal duplication) mode supported
- Power down mode supported
- 3.3V single voltage power supply
- No external components required for PLLs
- 64pin TSSOP with Exposed PAD (0.5mm lead pitch)

Block Diagram

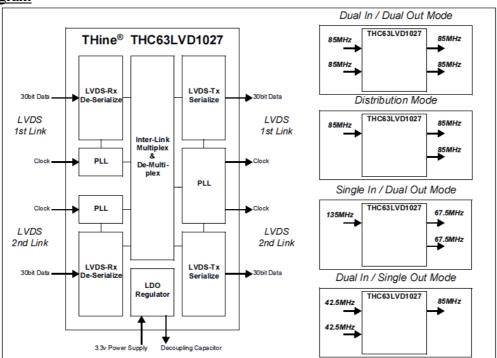
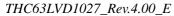


Figure 1. Block Diagram

1







Pin Diagram

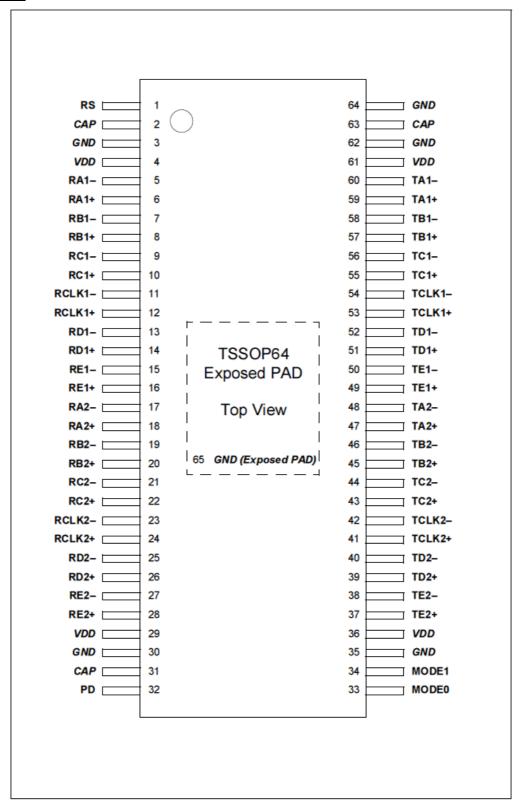
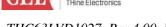
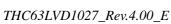


Figure 2. Pin Diagram







Pin Description

Table 1. Pin Description

Pin Name	Direction	Туре			Descripti	on			
RA1+/-		<i>J</i> P ·	LVDS data input for channel A of 1st Link						
RB1+/-						B of 1st Link			
RC1+/-	-					C of 1st Link			
RD1+/-	-					of 1st Link			
RE1+/-	-					E of 1st Link			
RCLK1+/-	-				or 1st Link	E Of 1St Link			
	-					-£241:1-			
RA2+/-	Input					of 2nd Link			
RB2+/-	-					3 of 2nd Link			
RC2+/-	1					C of 2nd Link			
RD2+/-	<u> </u>					of 2nd Link			
RE2+/-						E of 2nd Link			
RCLK2+/-			LVDS clo	ck input f	or 2nd Link	ζ			
		LVDS			in/Dual-out mod ow in this page.)	de,RCLK2+/- must be Hi-Z.			
TA1+/-						A of 1st Link			
TB1+/-	-					B of 1st Link			
TC1+/-	-								
	-								
TD1+/-	-		LVDS data output for channel C of 1st Link LVDS data output for channel D of 1st Link LVDS data output for channel E of 1st Link						
TE1+/-	-								
TCLK1+/-	Output		LVDS clock output for 1st Link LVDS data output for channel A of 2nd Link LVDS data output for channel B of 2nd Link LVDS data output for channel C of 2nd Link						
TA2+/-									
TB2+/-									
TC2+/-									
TD2+/-						D of 2nd Link			
TE2+/-			LVDS dat	a output f	for channel	E of 2nd Link			
TCLK2+/-			LVDS clo	ck output	for 2nd Lir	ık			
PD			Power Do	wn					
			H: Normal o						
DC	-					gnals turn to Hi-Z			
RS			H: Normal s		level select	tion			
			L: Reduced						
MODE1	Insect	LV-TTL	Mode sele						
MODE0	Input	LV-IIL	MODE1	MODE0	RCLK2+/-	Description			
			L	L	Clkin	Dual-in/Dual-out mode			
			L	L	Hi-Z	Distribution mode			
			H L	L H	H1-Z Clkin	Single-in/Dual-out mode Dual-in/Single-out mode			
			H	Н	-	Reserved			
					in/Dual-out mod	de, RCLK2+/- must be Hi-Z.			
VDD			3.3V power						
GND	Power	_				also Ground)			
CAP	10,,01		Decouplin			and Givana)			
\(\frac{1}{2}\)						l decoupling capacitors(Ccap).			
			Recommende						
l .	1								



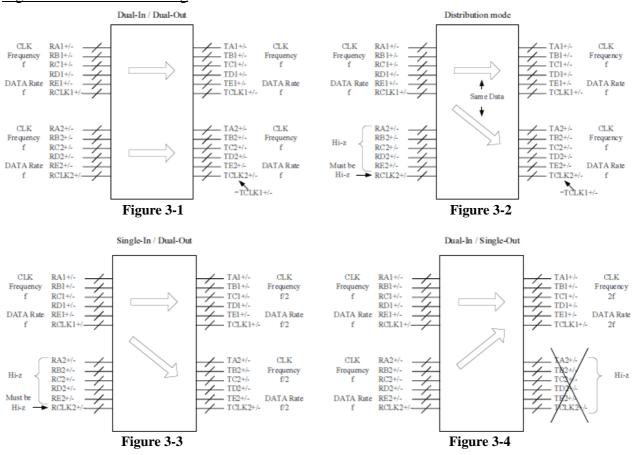


Mode Setting

Table 2. Mode Setting

Input/Output	RCLK2+/-	MODE1	MODE0
		(Input mode)	(Output mode)
		H: Single	H: Single
		L: Dual	L: Dual
Dual-In/Dual-Out	CLK in	L	L
(Fig.3-1,14-1)			
Distribution	Hi-Z	L	L
(Fig.3-2,14-2)			
Single-In/Dual-Out	Hi-Z	Н	L
(Fig.3-3,14-3)			
Dual-In/Single-Out	CLK in	L	Н
(Fig.3-4,14-4)			
Reserved	-	Н	Н

Signal Flow for Each Setting







Output Control / Fail Safe

THC63LVD1027 has a function to control output depending on LVDS input condition.

Table 3. Output Control

PD	RCLK1+/-	RCLK2+/-	Output
L	*	*	All Hi-Z
Н	Hi-Z	*	All Hi-Z
Н	CLK in	CLK in	Refer to p.4 Mode Setting #
Н	CLK in	Hi-Z	Refer to p.4 Mode Setting #

^{*:} Don't care

For fail-safe purpose, all LVDS input pins are connected to VDD via resistance for detecting Hi-Z state.

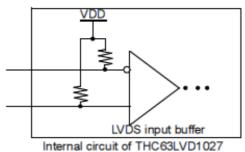
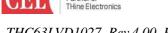
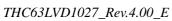


Figure 4. Fail Safe Circuit

^{#:} If a particular input data pair is Hi-Z, the corresponding output data become L according to LVDS DC spec.







Absolute Maximum Ratings

Table 4. Absolute Maximum Rating

Parameter	Min	Max	Unit
Power Supply Voltage	-0.3	+4.0	V
LVDS Input Voltage	-0.3	$V_{DD} + 0.3$	V
Junction Temperature	-	125	°C
Storage Temperature	-55	125	°C
Reflow Peak Temperature / Time	-	260 / 10sec	°C
Maximum Power Dissipation @+25°C	-	2.5	W

Operating Conditions

Table 5. Operating Condition

		ore or operation				
Symbol	Paramete	r	Min	Тур	Max	Unit
Ta	Operating Ambient Temperature		-40	25	+85	°C
V_{DD}	Power Supply Voltage	ge	3.0	3.3	3.6	V
	Dual-In/Dual-Out	Input	20	-	85	MHz
		Output	20	-	85	MHZ
	Distribution	Input	20	-	85	MHz
TC.	Distribution	Output	20	-	85	WITIZ
$\mathbf{F_{clk}}$	Single-In/Dual-Out	Input	40	-	135	MHz
	Single-in/Dual-Out	Output	20	-	67.5	MITIZ
	Dual-In/Single-Out	Input	20	-	42.5	MHz
	Duai-m/single-Out	Output	40	-	85	IVITIZ





Power Consumption

Table 6. Power Consumption

Symbol	Parameter		Conditions		Min	Тур.	Max	Unit
			CLKIN=40MHz		-	-	265	
		Dual-In/Dual-Out	CLKIN=65MHz		-	-	305	A
	Operating Current (Worst Case Pattern) Fig 5. Power Down Current	Duai-III/Duai-Out	CLKIN=75MHz		-	-	325	mA
			CLKIN=85MHz		ı	-	340	
			CLKIN=40MHz		-	-	215	
		Distribution	CLKIN=65MHz		-	-	235	A
		Distribution	CLKIN=75MHz	$R_{L Tx} = 100\Omega$	-	-	245	mA
	Operating Current		CLKIN=85MHz	2_111	ı	-	260	
т	(Worst Case Pattern)	attern)	CLKIN=40MHz	CL=5pF	ı	-	175	
I_{CCW}			CLKIN=65MHz	RS=VDD	ı	-	190	
	Fig 5.		CLKIN=75MHz		-	-	200	mA
		Single-In/Dual-Out	CLKIN=85MHz	Fig 6.	ı	-	210	
			CLKIN=112MHz		-	-	230	
			CLKIN=135MHz		-	-	250	
			CLKIN=20MHz		-	-	215	
		Dual In/Single Out	CLKIN=32.5MHz		-	-	235	mA
		Dual-In/Single-Out	CLKIN=37.5MHz			-	245	
			CLKIN=42.5MHz		-	-	260	
I _{CCS}	Power Down Current	-	-	-	-	-	8	mA

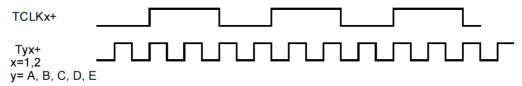


Figure 5. Test Pattern (LVDS Output Full Toggle Pattern)

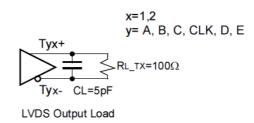


Figure 6. LVDS Output Load



Electrical Characteristics

DC Specifications

Table 7. DC Specifications

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CAP}	Capacitor pin appearance voltage	C _{CAP} =0.1μF	-	1.8	-	V
V_{IL}	LV-TTL Input Low Voltage	-	GND	-	0.8	V
V_{IH}	LV-TTL Input High Voltage	-	2.0	-	VDD	V
I _{IN_TTL}	LV-TTL Input Leakage Current	-	-4	-	+4	μΑ

LVDS Receiver DC Specifications

Table 8. LVDS Receiver DC Specifications

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{IN_RX}	LVDS-Rx Input Voltage Range	-	0.3	-	2.1	V
V _{IC_RX}	LVDS-Rx Common Voltage	-	0.6	1.2	1.8	V
V_{TH_RX}	LVDS-Rx Differential High Threshold	V 1.2V	-	-	+100	
V_{TL_RX}	LVDS-Rx Differential Low Threshold	$V_{IC_RX} = 1.2V$	-100	-	-	mV
$ \mathbf{V}_{\mathbf{ID_RX}} $	LVDS-Rx Differential Input Voltage	-	100	-	600	
		PD=VDD	-0.3	-	+0.3	mA
I_{IN_RX}	LVDS-Rx Input Leakage Current	PD=GND Vin=GND or VDD	-10	-	+10	μΑ

LVDS Transmitter DC Specifications

Table 9. LVDS Transmitter DC Specifications

Symbol	Parameter	(Conditions	Min	Тур	Max	Unit		
V _{OC_TX}	LVDS-Tx Common Voltage		-	1.125	1.25	1.375	V		
ΔV_{OC_TX}	Change in VOC between complementary output states	$R_{L_{\perp}TX} = -100\Omega$	D.	D	-	-	-	35	mV
187	LVDS-Tx Differential		Normal Swing	250	350	450	mV		
V _{OD_TX}	Output Threshold	10052	Reduced Swing	100 200	300	III V			
ΔV_{OD_TX}	Change in VOD between complementary output states		-	-	-	35	mV		
I _{OS_TX}	LVDS-Tx Output Short Current	V _{DD} =3.3V	V _{out} =GND	-24	-	-	mA		
I _{OZ_TX}	LVDS-Tx Output Tri-state Current	PD=GND	V _{out} =GND to VDD	-10	-	+10	μΑ		





AC Specifications

Table 10. AC Specifications

Symbol	Parameter	Cond	itions	Min	Тур	Max	Unit
t _{LT}	Phase Lock Loop Set Time (Fig 7.)	-	-	-	-	10	ms
		Dual-In/Dual-Out	CLKIN=75MHz	$9t_{RCP}+3$	9t _{RCP} +5	9t _{RCP} +7	
t _{DL} Data Latency (Fig 8.)	Distribution	CLKIN=75MHz	9t _{RCP} +3	9t _{RCP} +5	9t _{RCP} +7		
	Data Latency (Fig 8.)	Single-In/Dual-Out	CLKIN=75MHz	(11+2/7)t _{RCP} +3	(11+2/7)t _{RCP} +5	(11+2/7)t _{RCP} +7	ns
		Dual-In/Single-Out	CLKIN=37.5MHz	(11+2/7)t _{RCP} +3	(11+2/7)t _{RCP} +5	(11+2/7)t _{RCP} +7	
$t_{ m DEH}$	DE Input High Time (Fig 9.)		-	$2t_{RCP}$	-	-	
t _{DEL}	DE Input Low Time (Fig 9.)	Single-In/Dual-Out	-	2t _{RCP}	-	-	ns
t _{DEINT}	DE Input Period (Fig 9.)		-	4t _{RCP}	Must be 2n t _{RCP} (n=integer)	-	

AC Timing Diagrams

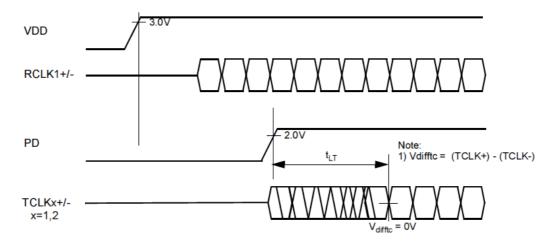


Figure 7. Phase Lock Loop Set Time





AC Timing Diagrams(Continued)

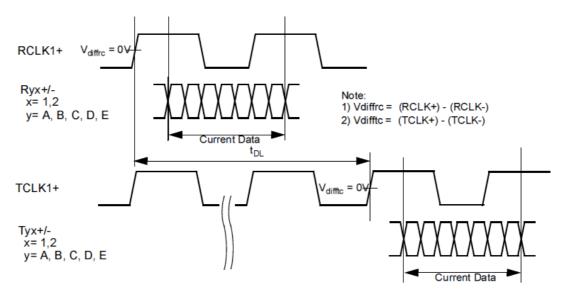


Figure 8. DATA Latency

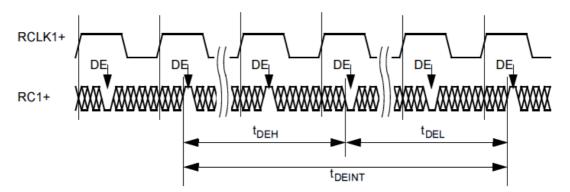


Figure 9. Single Link Input / Dual Link Output Mode RC1(DE) Input Timing





LVDS Receiver AC Specifications

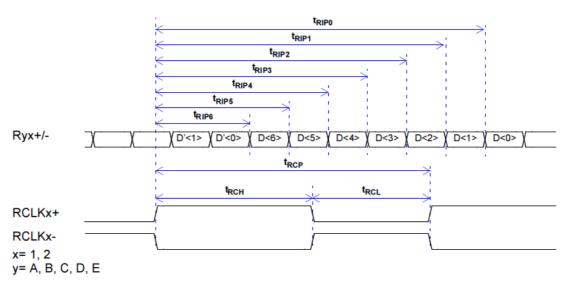
Table 11. LVDS Receiver AC Specifications

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _{RCP}	LVDS Clock Period	-	7.4	-	50	
t _{RCH}	LVDS Clock High Duration	-	2/7t _{RCP}	4/7t _{RCP}	5/7t _{RCP}	ns
t _{RCL}	LVDS Clock Low Duration	-	2/7t _{RCP}	3/7t _{RCP}	5/7t _{RCP}	
		CLKIN=75MHz ⁽¹⁾	480	-	-	
t_{RSUP}	LVDS Data Input Setup Margin	CLKIN=112MHz ⁽¹⁾	250	-	-	ps
		CLKIN=135MHz ⁽¹⁾	220	-	-	
		CLKIN=75MHz ⁽¹⁾	480	-	-	
t_{RHLD}	LVDS Data Input Hold Margin	CLKIN=112MHz ⁽¹⁾	250	-	-	ps
		CLKIN=135MHz ⁽¹⁾	220	-	-	
t _{RIP6}	LVDS Data Input Position 6	-	2/7t _{RCP} -t _{RHLD}	2/7t _{RCP}	2/7t _{RCP} +t _{RSUP}	
t _{RIP5}	LVDS Data Input Position 5	-	3/7t _{RCP} -t _{RHLD}	3/7t _{RCP}	3/7t _{RCP} +t _{RSUP}	
t _{RIP4}	LVDS Data Input Position 4	-	4/7t _{RCP} -t _{RHLD}	4/7t _{RCP}	4/7t _{RCP} +t _{RSUP}	
t _{RIP3}	LVDS Data Input Position 3	-	5/7t _{RCP} -t _{RHLD}	5/7t _{RCP}	5/7t _{RCP} +t _{RSUP}	ps
t _{RIP2}	LVDS Data Input Position 2	-	6/7t _{RCP} -t _{RHLD}	6/7t _{RCP}	6/7t _{RCP} +t _{RSUP}	
t _{RIP1}	LVDS Data Input Position 1	-	7/7t _{RCP} -t _{RHLD}	7/7t _{RCP}	7/7t _{RCP} +t _{RSUP}	
t _{RIP0}	LVDS Data Input Position 0	-	8/7t _{RCP} -t _{RHLD}	8/7t _{RCP}	8/7t _{RCP} +t _{RSUP}	
t _{CK12}	Skew Time Between RCLK1 and RCLK2	-	-0.3 t _{RCP}	-	+0.3 t _{RCP}	ps

⁽¹⁾ $V_{IC_RX}=1.2V$, $t_{RCH}=4/7$ t_{RCP}



LVDS Receiver Input Timing



Ry1+/- skew margin is the one between RCLK1+/- and Ry1+/-.

Ry2+/- skew margin is the one between RCLK2+/- and Ry2+/-.

Figure 10. LVDS Receiver Timing

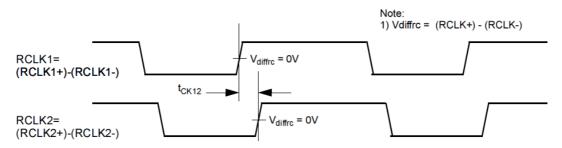


Figure 11. Skew time between RCLK1 and RCLK2

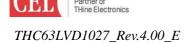




LVDS Transmitter AC Specifications

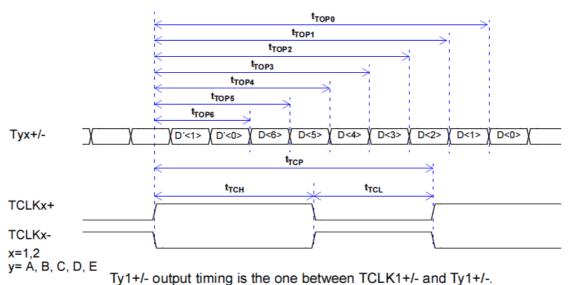
Table 12. LVDS Transmitter AC Specifications

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _{TCP}	LVDS Clock Period	-	11.76	-	50	
t_{TCH}	LVDS Clock High Duration	-	-	4/7t _{TCP}	-	ns
t_{TCL}	LVDS Clock Low Duration	-	-	3/7t _{TCP}	-	
t_{TSUP}	LVDS Data Output Setup	CLKOUT=75MHz	-	-	250	ps
t _{THLD}	LVDS Data Output Hold	CLKOUT=75MHz	-	-	250	ps
t _{TOP6}	LVDS Data Output Position 6	-	2/7t _{TCP} -t _{THLD}	2/7t _{TCP}	2/7t _{TCP} +t _{TSUP}	
t _{TOP5}	LVDS Data Output Position 5	-	3/7t _{TCP} -t _{THLD}	3/7t _{TCP}	3/7t _{TCP} +t _{TSUP}	
t _{TOP4}	LVDS Data Output Position 4	-	4/7t _{TCP} -t _{THLD}	4/7t _{TCP}	4/7t _{TCP} +t _{TSUP}	
t_{TOP3}	LVDS Data Output Position 3	-	5/7t _{TCP} -t _{THLD}	5/7t _{TCP}	5/7t _{TCP} +t _{TSUP}	ps
t _{TOP2}	LVDS Data Output Position 2	-	6/7t _{TCP} -t _{THLD}	6/7t _{TCP}	6/7t _{TCP} +t _{TSUP}	
t _{TOP1}	LVDS Data Output Position 1	-	7/7t _{TCP} -t _{THLD}	7/7t _{TCP}	7/7t _{TCP} +t _{TSUP}	
t_{TOP0}	LVDS Data Output Position 0	-	8/7t _{TCP} -t _{THLD}	8/7t _{TCP}	8/7t _{TCP} +t _{TSUP}	
$t_{ m LVT}$	LVDS Transition Time (Fig 13.)	Fig.6	-	0.6	1.5	ns





LVDS Transmitter Output Diagram



Ty2+/- output timing is the one between TCLK2+/- and Ty2+/-.

Figure 12. LVDS Transmitter Timing

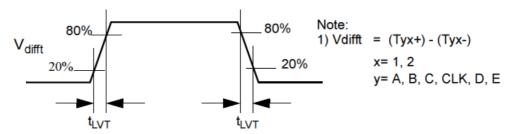


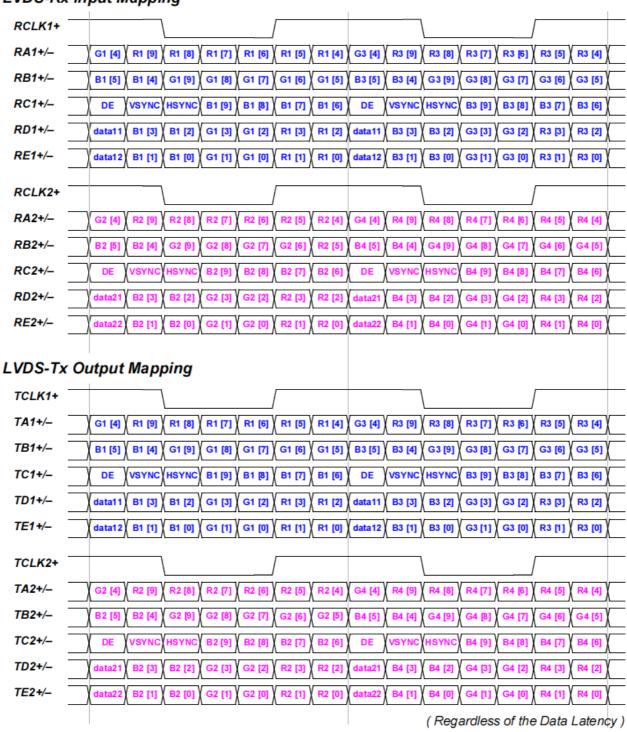
Figure 13. LVDS Transition Timing





LVDS Data Mapping

Dual-In / Dual-Out LVDS-Rx Input Mapping



Data bits "data11, data12, data21, data22" are available for additional data transmission.

Figure 14-1. Data Mapping for Dual-In/Dual-Out



Distribution Mode

In Distribution mode, RCLK2+/- must be Hi-Z.



Data bits "data11, data12" are available for additional data transmission.

Figure 14-2. Data Mapping for Distribution mode

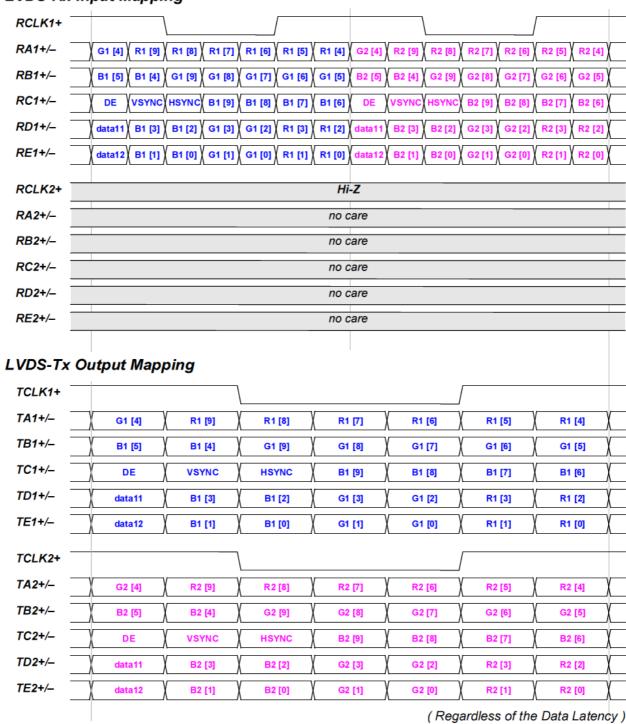




Single-In / Dual-Out

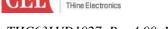
In Single-in / Dual-out mode, RCLK2+/- must be Hi-Z.

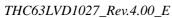
LVDS-Rx Input Mapping



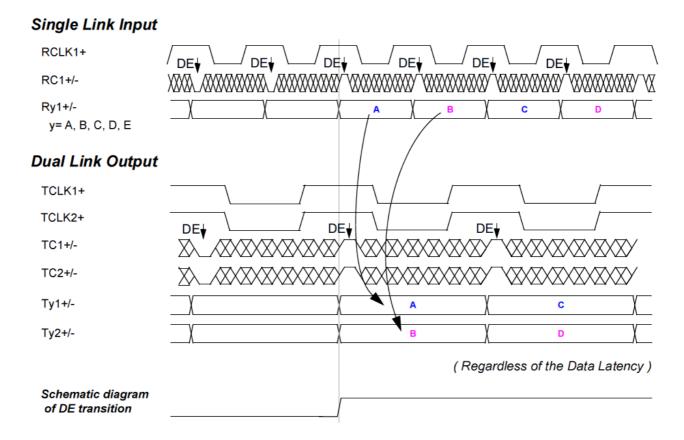
Data bits "data11, data12" are available for additional data transmission.

Figure 14-3(a). Data Mapping for Single-In/Dual-Out







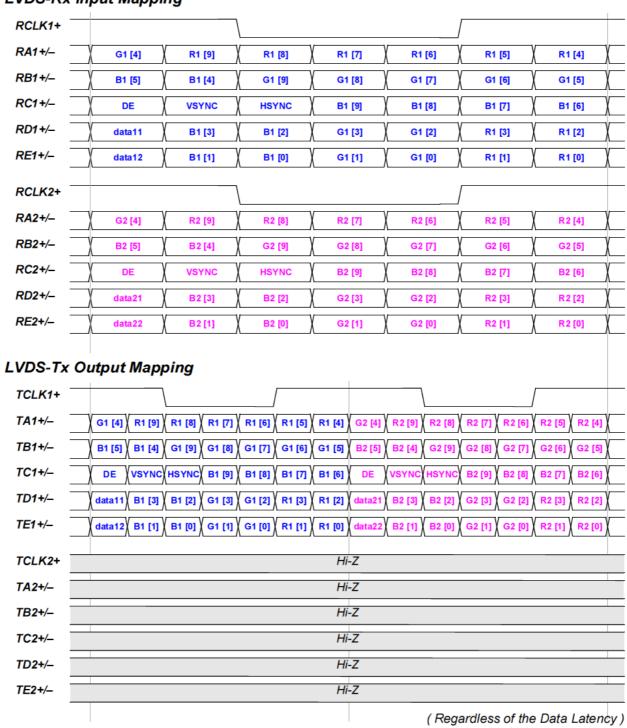


Single-in / Dual-out mode uses DE signal L-to-H-edge to start distribution of input data.

Figure 14-3(b). Data Mapping for Single-In/Dual-Out



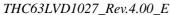
Dual-In / Single-Out LVDS-Rx Input Mapping



Data bits "data11, data12, data21, data22" are available for additional data transmission.

Figure 14-4. Data Mapping for Dual-In/Single-Out

Notes





1) LVDS input pin connection

When LVDS line is not derived from the previous device, the line is pulled up to 3.3V internally in THC63LVD1027. This can cause violation of absolute maximum ratings to the previous LVDS Tx device whose operating condition is lower voltage power supply than 3.3V. This phenomenon may happen at power on phase of the whole system including THC63LVD1027. One solution for this problem is PD=L control during no LVDS input period because pull-up resistors are cut off at power down state.

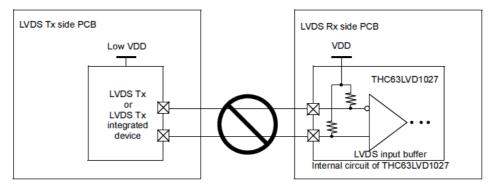
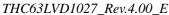


Figure 15. LVDS input pin connection

2) Power On Sequence

Don't input RCLK1+/- and RCLK2+/- before THC63LVD1027 is on in order to keep absolute maximum ratings.





3) Cable Connection and Disconnection

Don't connect and disconnect the LVDS cable, when the power is supplied to the system.

4)GND Connection

Connect the each GND of the PCB which Transmitter, Receiver and THC63LVD1027 on it. It is better for EMI reduction to place GND cable as close to LVDS cable as possible.

5) Multi Drop Connection

Multi drop connection is not recommended.

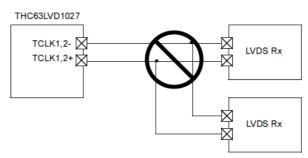


Figure 16.Multi Drop Connection

6) Asynchronous use

Asynchronous use such as following systems are not recommended. Page.11 tCK12 spec should be kept.

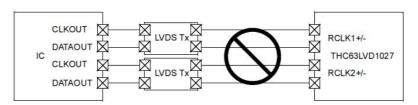


Figure 17-1. Asynchronous Use1

Asynchronous use such as following systems are not recommended.

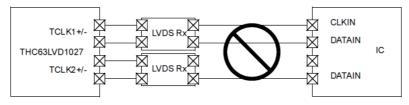
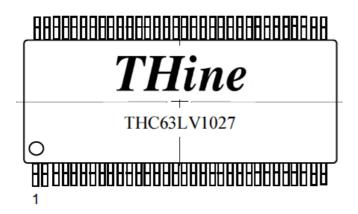


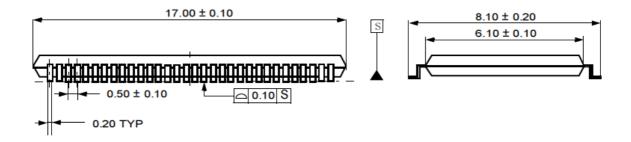
Figure 17-2. Asynchronous Use2

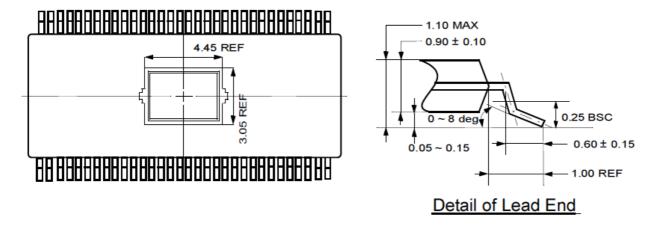




Package





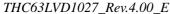


Unit: mm

Exposed PAD is GND and must be soldered to PCB.

Figure 18. Package Diagram







Notices and Requests

- 1. The product specifications described in this material are subject to change without prior notice.
- 2. The circuit diagrams described in this material are examples of the application which may not always apply to the customer's design. We are not responsible for possible errors and omissions in this material. Please note if errors or omissions should be found in this material, we may not be able to correct them immediately.
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- 4. Note that if infringement of any third party's industrial ownership should occur by using this product, we will be exempted from the responsibility unless it directly relates to the production process or functions of the product.
- 5. This product is presumed to be used for general electric equipment, not for the applications which require very high reliability (including medical equipment directly concerning people's life, aerospace equipment, or nuclear control equipment). Also, when using this product for the equipment concerned with the control and safety of the transportation means, the traffic signal equipment, or various Types of safety equipment, please do it after applying appropriate measures to the product.
- 6. Despite our utmost efforts to improve the quality and reliability of the product, faults will occur with a certain small probability, which is inevitable to a semi-conductor product. Therefore, you are encouraged to have sufficiently redundant or error preventive design applied to the use of the product so as not to have our product cause any social or public damage.
- 7. Please note that this product is not designed to be radiation-proof.
- 8. Customers are asked, if required, to judge by themselves if this product falls under the category of strategic goods under the Foreign Exchange and Foreign Trade Control Law.

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